

TMUX9832 No High Voltage Bias, Beyond the Supply, 220 V 1:1, 32-Channel Switch With Latch-Up Immunity

1 Features

- Only +5 V bias supply required
 - Very low power: 9.5 mW (typ) all 32CH switching at 50 kHz
- Wide input signal range:
 - Up to ± 110 V, 220 V_{PP}
 - ± 120 V, 240 V_{PP} voltage overshoots supported
- Low off capacitance: 10.6 pF
- Low on resistance
- Up to 100 MHz data shift clock frequency
- Logic levels: 1.8 V to 5 V
- Integrated NDIN to invert input data polarity
- Fast turn-on time: 3 μ s (maximum)
- Excellent HD2PC performance: -65 dB at 5 MHz
- Small BGA and QFN package options with optimized pin-out
- Integrated thermal shutdown for improved system reliability
- Integrated bleed resistors on the outputs
- Latch-up immunity by device construction
- Extended temperature range: -40°C to 125°C

2 Applications

- [Medical ultrasound imaging](#)
- [Ultrasound smart probe](#)
- Non-destructive testing (NDT) metal flaw detection
- Piezoelectric transducer drivers
- [Ultrasonic flow transmitters](#)
- [Printers](#)
- [Optical MEMS modules](#)

3 Description

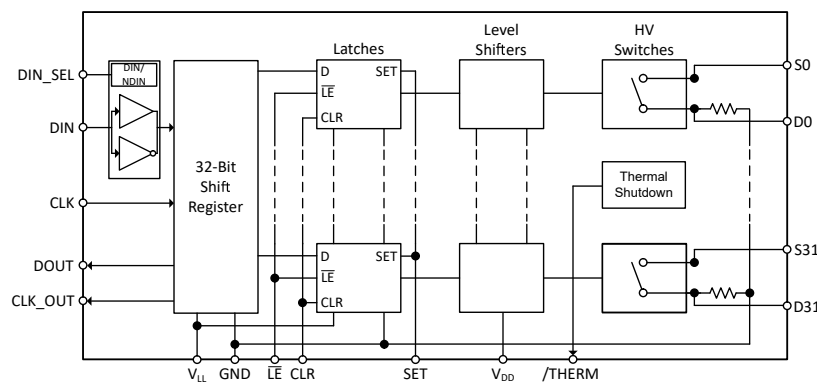
The TMUX9832 is a 32-channel low harmonic distortion, low resistance, low capacitance high-voltage analog switch integrated circuit (IC) with latch-up immunity. Each device has 32 independently selectable 1:1, single-pole, single-throw (SPST) switch channels. The device only requires a +5 V supply, while still being able to support ± 110 V analog signals. TMUX9832 also integrates bleed resistors on its drain (Dx) pins to discharge capacitive loads, like piezoelectric transducers. TMUX9832 is designed for medical ultrasound imaging and other piezoelectric transducer driver applications.

TMUX9832 integrates cascadable 32-bit shift register with latches for controlling each of the 32 switches. The daisy chain capability allows for many TMUX9832 devices to be controlled without requiring a separate chip-select for every device. To reduce noise in the signal path due to potential clock feed-through, the active low latch enable can be held high while data is loaded into the shift registers. The 32-bit shift register can operate off of a 1.8 V – 5 V power supply and support clock speeds up to 100 MHz.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
TMUX9832	RWF (VQFN)	10 mm × 10 mm
	ZEH (NFBGA)	7.5 mm × 7.5 mm

- (1) For all available packages, see the orderable addendum at the end of the data sheet.
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.



Simplified Schematic



Table of Contents

1 Features	1	5.3 Trademarks.....	3
2 Applications	1	5.4 Electrostatic Discharge Caution.....	3
3 Description	1	5.5 Glossary.....	3
4 Revision History	2	6 Mechanical, Packaging, and Orderable Information	3
5 Device and Documentation Support	3	6.1 Mechanical Data.....	3
5.1 Receiving Notification of Documentation Updates.....	3	6.2 Tape and Reel Information.....	4
5.2 Support Resources.....	3		

4 Revision History

DATE	REVISION	NOTES
June 2023	*	Initial Release

5 Device and Documentation Support

5.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

5.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

5.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.
All trademarks are the property of their respective owners.

5.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

5.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

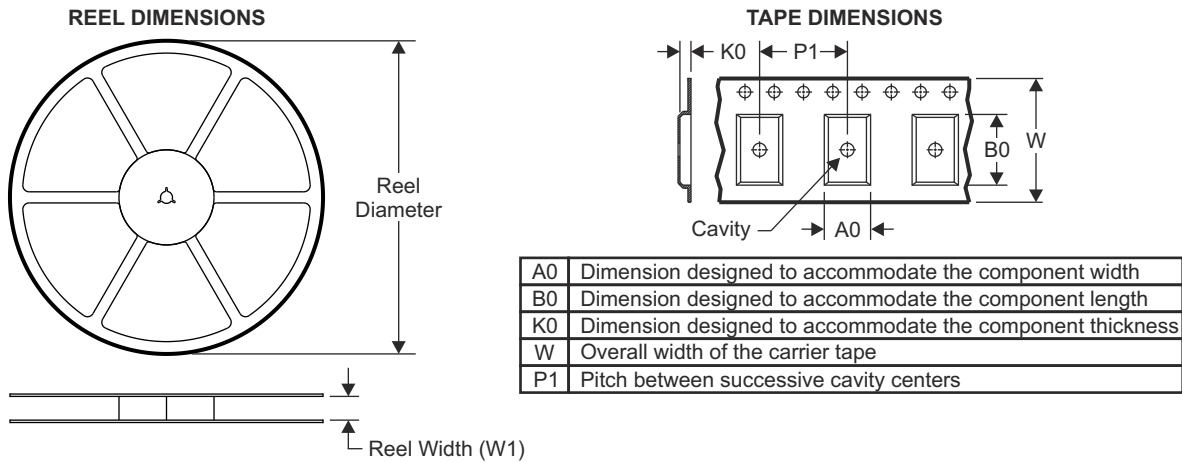
6 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

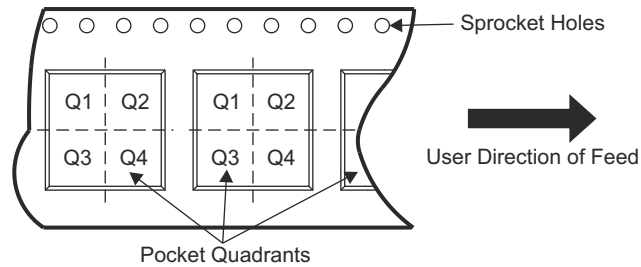
6.1 Mechanical Data

For package drawing information, request access to full data sheet at [myTI account](#).

6.2 Tape and Reel Information



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

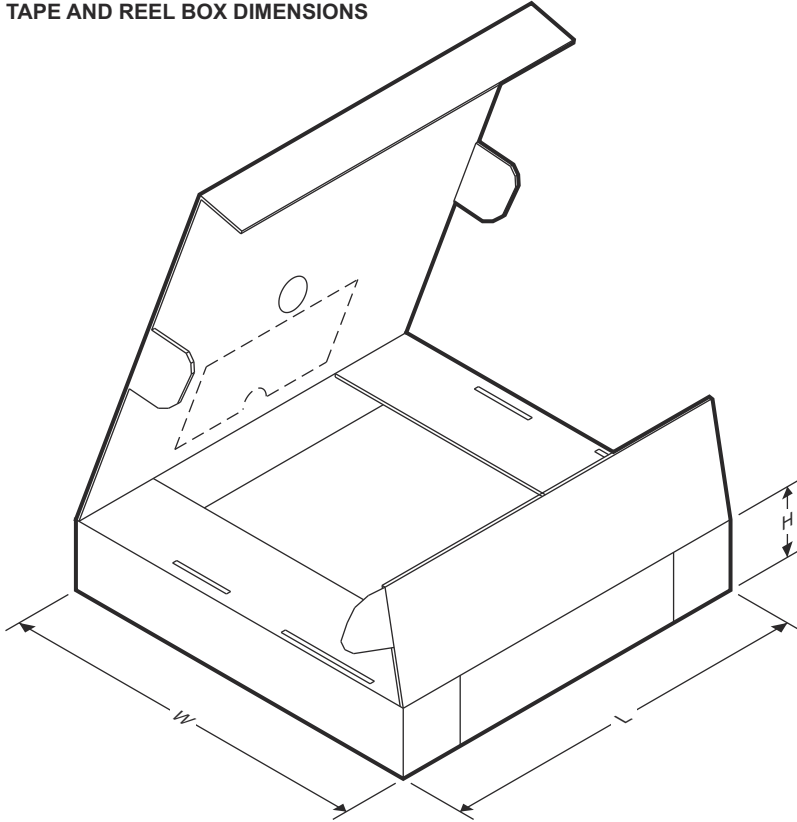


Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TMUX9832ZEHR	NFBGA	ZEH	(1)	2000	330	16.4	7.85	7.85	2.25	12	16	Q3

(1) For pin count information, request access to full data sheet at [myTI account](#)

ADVANCE INFORMATION

TAPE AND REEL BOX DIMENSIONS



Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TMUX9832ZEHR	NFBGA	ZEH	(1)	2000	336.6	336.6	31.8

(1) For pin count information, request access to full data sheet at [myTI account](#)

ADVANCE INFORMATION

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
PTMUX9832RWFR	Active	Preproduction	VQFN (RWF) 72	2500 LARGE T&R	-	Call TI	Call TI	-40 to 85	PTMUX9832
PTMUX9832RWFR.B	Active	Preproduction	VQFN (RWF) 72	2500 LARGE T&R	-	Call TI	Call TI	-40 to 85	PTMUX9832
PTMUX9832ZEHR	Active	Preproduction	NFBGA (ZEH) 83	2500 LARGE T&R	-	Call TI	Call TI	-40 to 85	
PTMUX9832ZEHR.B	Active	Preproduction	NFBGA (ZEH) 83	2500 LARGE T&R	-	Call TI	Call TI	-40 to 85	

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025